

### SUBMISSION OF FORMAL DRAWINGS Serial No. 09/880,465

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# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

#### PATENT APPLICATION

Applicant: Seutter, et al.

Case: 5643/CALB/L/B

Serial No.: 09/880,465

Filed: June 12, 2001

Examiner: Ha T. Nguyen

Group Art Unit: 2812

Title:

LOW-RESISTIVITY TUNGSTEN FROM HIGH-PRESSURE

CHEMICAL VAPOR DEPOSITION USING METAL-ORGANIC

**PRECURSOR** 

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

SIR:

# SUBMISSION OF FORMAL DRAWINGS

The Applicants submit herewith  $\underline{6}$  replacement sheets of formal drawings (FIGS. 1 through 5B) in connection with the above-captioned application.

Respectfully submitted,

<u>10/303</u>

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## CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited on October 3, 2003 with the United States Postal Service as first-class mail, with sufficient postage, in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Signature

Date of signature